IPC  ASSOCIATION CONNECT ELECTRONICS INDUSTR	© Copyright 2005. II	aterial Composition Declaration Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both ernational and Pan-American copyright conventions.			der both	This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.									
752-21.1					Form Type Distribute	* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ials and Mfg Information				
upplier Infor	mation														
Company name*			Company unique ID			J	Unique ID Authority				Response Date*				
nsemi											2025-09-15				
Contact Name			Title - Contact			I	Phone - Contact*				Email - Contact*				
Product-Env-Stev	wards		Product Enviro Compliance			]	NA				Product-Env-Stewards@onsemi.com				
uthorized Repre	sentative*	Title - Representative			I	Phone - Representative*				Email - Representative*					
Product-Env-Stev	wards		Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com				
Reques	ster Item Number	Mfr Item Number		Mfr Item Name			Effective Date	Version	N	Manufacturing Site		Veight*	UOM	Unit Type	
	MC33161DMR2G ANA UNIV VC		ANA UNIV VOLT	MONITOR	2025-09-15		N	MY1		1.93	mg	Each			
	g Process Informat														
ž ž			Terminal Base Alloy J-STD-020 MSL		. Rating	Peak Process Body Temperatu					per of Reflow Cyc	eles			
•	Γin (Sn) - annealed		U Alloy	1			260		C	30	second	ls  3			
omments															
	time at peak temperatu														
or more informa	tion regarding material	composition ]	please refer t	o page 3											

RoHS Material Composition Declaration			Declaration Type *	Detail	ed				
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		ium (Cr6+), Polybrominated Biphenyls (PB)	erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a						
cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan	nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C	enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega	s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this	dentified above. If a ally with lower level in is true and correct tion member state la mation. However, in ose certifications are ag any warranty righ	homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of				
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted				
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.									
Exemption List Version	EL-2011/534/EU								
Declaration Signature									
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the				

## **Homogeneous Material Composition Declaration for Electronic Products**

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	1.32	mg	Supplier	Silicon (Si)	7440-21-3		1.32	mg
Die Attach	0.91	mg		Resin	proprietary data		0.0728	mg
			Supplier	Silver (Ag)	7440-22-4		0.769	mg
			Supplier	Formaldehyde Polymer	9003-36-5		0.0683	mg
Lead Frame	14.26	mg	Supplier	Silver (Ag)	7440-22-4		0.3565	mg
			Supplier	Zinc (Zn)	7440-66-6		0.0143	mg
			Supplier	Iron (Fe)	7439-89-6		0.3422	mg
			Supplier	Copper (Cu)	7440-50-8		13.547	mg
Mold Compound-Black	14.96	mg		Epoxy resin	proprietary data		0.748	mg
			Supplier	Phenolic Resin	Proprietary Data		0.748	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		0.2992	mg
			Supplier	Carbon Black (C)	1333-86-4		0.0748	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		13.09	mg
Plating	0.38	mg	Supplier	Tin (Sn)	7440-31-5		0.38	mg
Wire Bond	0.1	mg	Supplier	Palladium (Pd)	7440-05-3		0.002	mg
			Supplier	Gold (Au)	7440-57-5		0.0005	mg
			Supplier	Copper (Cu)	7440-50-8		0.0975	mg